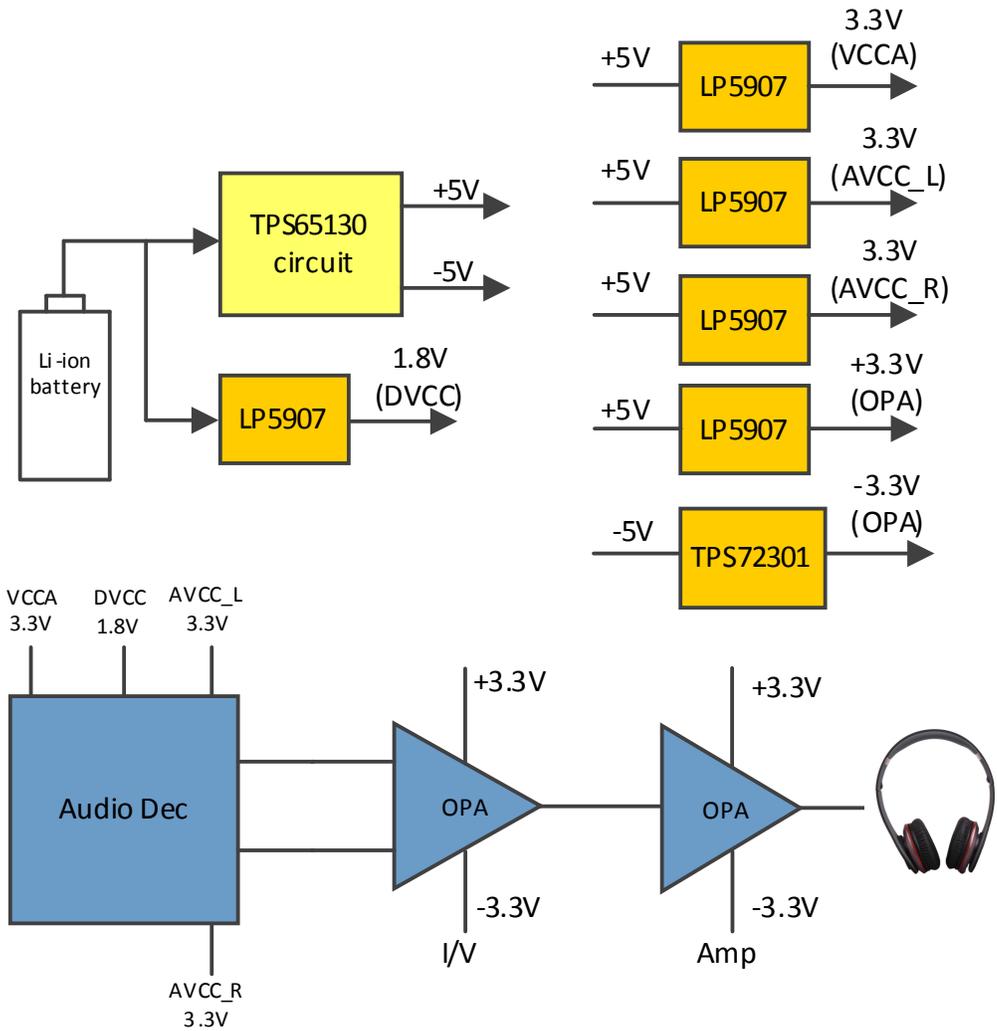
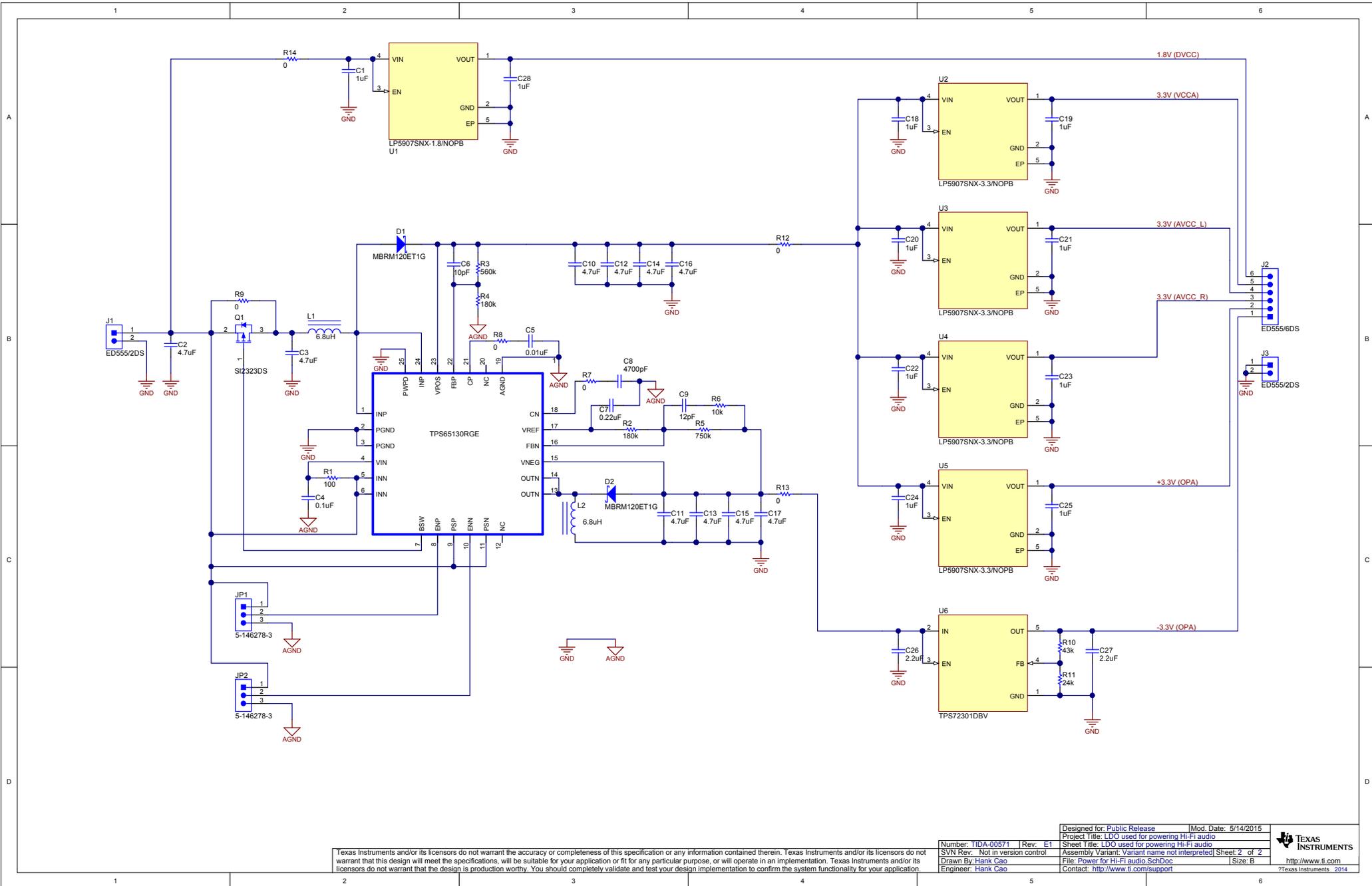


Revision History	
Revision	Notes



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Designed for: Public Release	Mod. Date: 5/6/2015
Project Title: LDO used for powering Hi-Fi audio	
Number: TIDA-00571	Rev: E1
SVN Rev: Not in version control	Assembly Variant: Variant name not interpreted
Drawn By: Hank Cao	File: Cover Sheet_ANSI-E_SchDoc
Engineer: Hank Cao	Contact: http://www.ti.com/support



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Number: TIDA-00571	Rev: E1	Mod. Date: 5/14/2015
Project Title: LDO used for powering Hi-Fi audio		
Sheet Title: LDO used for powering Hi-Fi audio		
SVN Rev: Not in version control	Assembly Variant: Variant name not interpreted	Sheet: 2 of 2
Drawn By: Hank Cao	File: Power for Hi-Fi audio SchDoc	Size: B
Engineer: Hank Cao	Contact: http://www.ti.com/support	

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